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A	<div>2024-07-18</div> <div>TH258A_MG32F04P032_TSSOP28_QFN32_EV_V10 >>> TH258A_MG32F04P032_TSSOP28_QFN32_EV_V11</div> <div>sch: 2_MG32F04P032_TSSOP28.SchDoc CN1-114 & R59--R60 net 由 PA0 >> PA0_BOOT0</div>						A											
	<div>2024-10-24</div> <div>TH258A_MG32F04P032_TSSOP28_QFN32_EV_V11</div> <div>sch: 2_MG32F04P032_TSSOP28.SchDoc U4: MG32F04P032 PIN Assign Change</div>																	
B	<div>2024-11-21</div> <div>TH258A_MG32F04P032_TSSOP28_QFN32_EV_V11 >>> TH258A_MG32F04P032_TSSOP28_QFN32_EV_V12</div> <div>sch: 1_MLink_V13 >> 1_MLink_V14</div> <div><div>1. Type-C CC1/CC2 對地電阻 5.1K (R26 , R27) ·</div><div>2. 84FG516 U2-7 的P2.2新增電阻對地 (R28) ·</div><div>EVB的MLink上新增電阻請放在既有空的位置 · 別移動其他原本零件位置</div></div> <div>sch: 2_MG32F005_TSSOP28 >> 2_MG32F005_TSSOP28_V11</div> <div><div>1. U4-9 PA10_nRST需接到connector CN1A-5 的PA10 net</div></div> <div>2024-12-02</div> <div>sch: 1_MLink_V13 >> 1_MLink_V14</div> <div><div>1. 金良 11/28和名瑞討論決議再追加 SWD (ICP) 輸出 Ti SN74LVC2T45 --U8 & U9 以求 MLINK電氣特性統一 --文魁已給sch</div></div> <div>EVB TH253A , TH255A,TH256A, TH257A, TH258A、TH273A on board MLink需修改兩個地方 其中TH257A與TH258A的PA10_nRST需接到connector 的PA10 net</div>						B											
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